

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	YIPING WANG	12/31/2014
	DONGLU BAI	12/31/2014
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<b>Postal Code:</b>	201203	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Patent Number:	8637566
<b>CORRESPONDENCE DATA</b>		
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<b>DATE SIGNED:</b>	01/29/2015	
<b>Total Attachments: 2</b>		
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## ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged,  
ASSIGNORS

Donglu Bai and Yiping Wang

hereby sell, assign and transfer to ASSIGNEE, Shanghai Institute of Materia Medica, Chinese Academy of Sciences, at 555 Zuchongzhi Road, Pudong, Shanghai 201203, China, and the successors, assigns and legal representatives of the ASSIGNEE all of their right, title and interest for the United States and its territorial possessions and in all foreign countries in and to any and all improvements which are disclosed in the invention entitled

### **Slow Infusion of Sulcardine and its Salts**

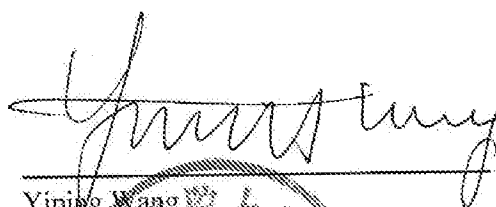
and which are found in PCT patent application No. PCT/US2010/056849, U.S. patent application No. 61/261,927, U.S. patent application No. 13/509,739 (issued as U.S. Patent No. 8,637,566), European patent application No. 10832056.5, Chinese patent application No. 201080051906.6, Japanese patent application No. 2013-511472, and Hong Kong patent application No. 13103596.7 entitled as above and listing the above named persons as inventors, and any legal equivalent thereof in a foreign country, including the right to claim priority and in and to all Letters Patent to be obtained for said invention by the above application or any continuation, divisional, continuation-in-part, conversion to 35 USC 111(a) or substitute thereof, and any reissue, reexamination or extension of said Letters Patent and all rights under all International Conventions for the Protection of Industrial Property;

ASSIGNORS hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNORS further covenant that ASSIGNEE will, upon request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNORS and will testify as to the same in any interference, litigation, or proceeding relating thereto and will promptly execute and deliver to ASSIGNEE, or its legal representative, any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue or enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

AND the ASSIGNORS request the Commissioner of Patents and Trademarks to issue said Letters Patent of the United States and any reissue or extension thereof to the ASSIGNEE, Shanghai Institute of Materia Medica, Chinese Academy of Sciences.

Executed this 31 day of December, 2014



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Executed this 31 day of December, 2014



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